

IGBT Module

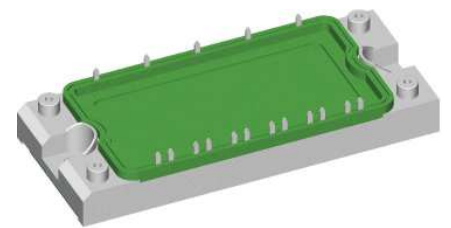
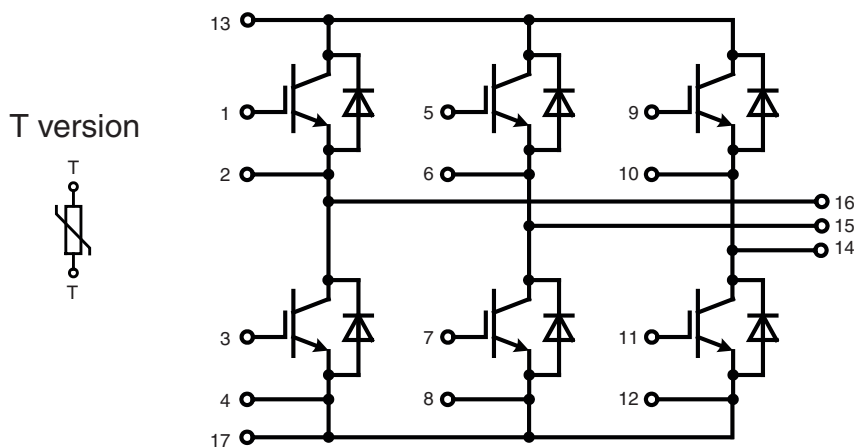
Sixpack

Short Circuit SOA Capability
Square RBSOA

$I_{C25} = 50\text{ A}$
 $V_{CES} = 1200\text{ V}$
 $V_{CE(sat)} \text{ typ.} = 2.2\text{ V}$

Part name (Marking on product)

MWI25-12A7
 MWI25-12A7T



E72873

Features:

- NPT IGBT technology
- low saturation voltage
- positive temperature coefficient for easy paralleling
- low switching losses
- switching frequency up to 30 kHz
- square RBSOA, no latch up
- high short circuit capability
- MOS input, voltage controlled
- ultra fast free wheeling diodes
- solderable pins for PCB mounting
- space savings
- reduced protection circuits

Application:

- AC motor control
- AC servo and robot drives power supplies

Package:

- UL registered
- Industry standard E2-pack
- package with copper base plate
- package designed for wave soldering

IGBTs							
Symbol	Definitions	Conditions	Ratings			Unit	
			min.	typ.	max.		
V_{CES}	collector emitter voltage		$T_{VJ} = 25^{\circ}\text{C}$ to 150°C			V	
V_{GES}	max. DC gate voltage	continuous			± 20	V	
V_{GEM}	max. transient collector gate voltage	transient			± 30	V	
I_{C25}	collector current		$T_C = 25^{\circ}\text{C}$			A	
I_{C80}			$T_C = 80^{\circ}\text{C}$			A	
P_{tot}	total power dissipation		$T_C = 25^{\circ}\text{C}$			W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 25\text{ A}; V_{GE} = 15\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$			V V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 1\text{ mA}; V_{GE} = V_{CE}$	4.5		6.5	V	
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$			mA mA	
I_{GES}	gate emitter leakage current	$V_{CE} = 0\text{ V}; V_{GE} = \pm 20\text{ V}$			200	nA	
C_{ies}	input capacitance	$V_{CE} = 25\text{ V}; V_{GE} = 0\text{ V}; f = 1\text{ MHz}$		1650		pF	
$Q_{G(on)}$	total gate charge	$V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 35\text{ A}$		120		nC	
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600\text{ V}; I_C = 25\text{ A}$ $V_{GE} = \pm 15\text{ V}; R_G = 47\ \Omega$	$T_{VJ} = 125^{\circ}\text{C}$			ns	
t_r	current rise time		100			ns	
$t_{d(off)}$	turn-off delay time		70			ns	
t_f	current fall time		500			ns	
E_{on}	turn-on energy per pulse		70			mJ	
E_{off}	turn-off energy per pulse		3.8			mJ	
I_{CM}	reverse bias safe operating area	$RBSOA; V_{GE} = \pm 15\text{ V}; R_G = 47\ \Omega$ $L = 100\ \mu\text{H};$ clamped induct. load $V_{CEmax} = V_{CES} - L_S \cdot di/dt$	$T_{VJ} = 125^{\circ}\text{C}$			70	A
t_{SC} (SCSOA)	short circuit safe operating area	$V_{CE} = V_{CES}; V_{GE} = \pm 15\text{ V};$ $R_G = 47\ \Omega;$ non-repetitive	$T_{VJ} = 125^{\circ}\text{C}$			10	μs
R_{thJC}	thermal resistance junction to case	(per IGBT)			0.55	K/W	

Diodes						
Symbol	Definitions	Conditions	Ratings			Unit
			min.	typ.	max.	
V_{RRM}	max. repetitive reverse voltage		$T_{VJ} = 150^{\circ}\text{C}$			V
I_{F25}	forward current		$T_C = 25^{\circ}\text{C}$			A
I_{F80}			$T_C = 80^{\circ}\text{C}$			A
V_F	forward voltage	$I_F = 25\text{ A}; V_{GE} = 0\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$			V V
I_{RM}	max. reverse recovery current	$V_R = 600\text{ V}$ $di_F/dt = -400\text{ A}/\mu\text{s}$ $I_F = 25\text{ A}; V_{GE} = 0\text{ V}$	$T_{VJ} = 125^{\circ}\text{C}$			A
t_{rr}	reverse recovery time		20			ns
$E_{rec(off)}$	reverse recovery energy		200			mJ
R_{thJC}	thermal resistance junction to case	(per diode)			1.19	K/W

 $T_C = 25^{\circ}\text{C}$ unless otherwise stated

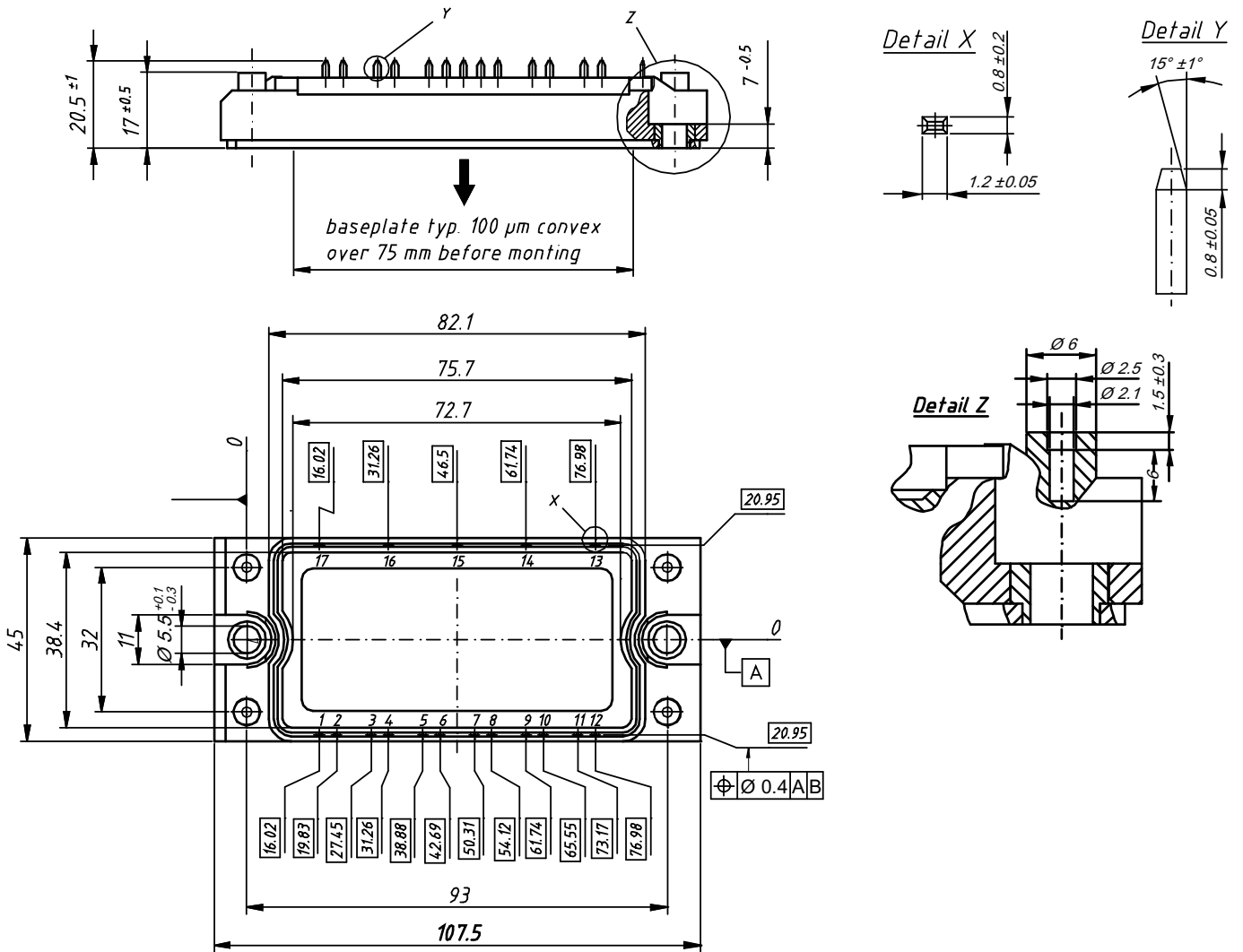
Module						
Symbol	Definitions	Conditions	Ratings			Unit
			min.	typ.	max.	
T_{VJ}	operating temperature		-40		125	°C
T_{VJM}	max. virtual junction temperature				150	°C
T_{stg}	storage temperature		-40		125	°C
V_{ISOL}	isolation voltage	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$			2500	V~
M_d	mounting torque	(M4)	2.7		3.3	Nm
d_S	creep distance on surface		6			mm
d_A	strike distance through air		6			mm
Weight				180		g
R_{thCH}	thermal resistance case to heatsink	with heatsink compound		0.02		K/W

Temperature Sensor NTC						
Symbol	Definitions	Conditions	Ratings			Unit
			min.	typ.	max.	
R_{25}	resistance	$T_C = 25^\circ\text{C}$	4.75	5.0	5.25	kΩ
$B_{25/50}$				3375		K

Equivalent Circuits for Simulation						
			Ratings			
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_0 R_0	IGBT	T1 - T6 $T_{VJ} = 125^\circ\text{C}$		1.5 40.7		V mΩ
V_0 R_0	Diode	D1 - D6 $T_{VJ} = 125^\circ\text{C}$		1.3 16		V mΩ
			$Z_{th}(t) = \sum_{i=1}^n \left[R_i \cdot \left(1 - \exp\left(-\frac{t}{\bar{A}_i}\right) \right) \right]$ $\bar{A}_i = R_i \cdot C_i$			
R_1				-		
R_2				-		
C_1				-		
C_2				-		
				IGBT		Diode

Outline Drawing

Dimensions in mm (1 mm = 0.0394")



Product Marking

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MWI 15-12A7	MWI15-12A7	Box	10	482730
Standard	MWI 15-12A7T	MWI15-12A7T	Box	10	480819

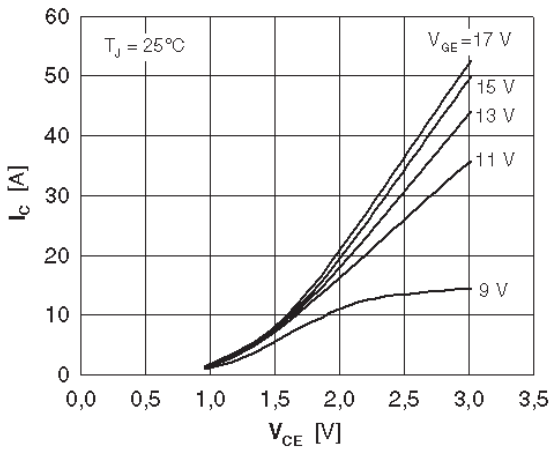


Fig. 1 Typ. output characteristics

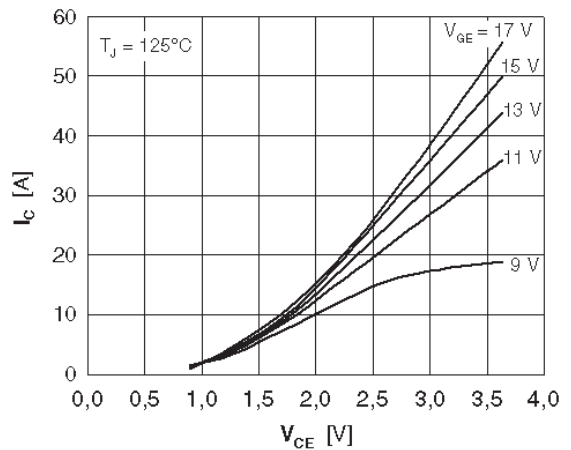


Fig. 2 Typ. output characteristics

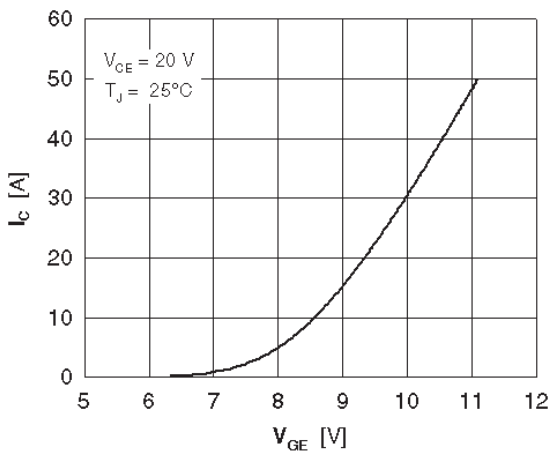


Fig. 3 Typ. transfer characteristics

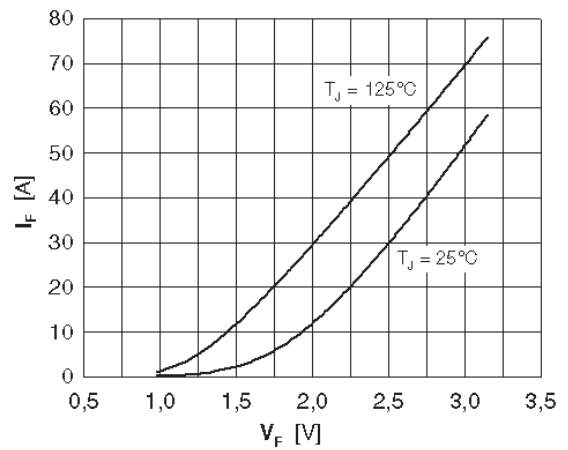


Fig. 4 Typ. forward characteristics of free wheeling diode

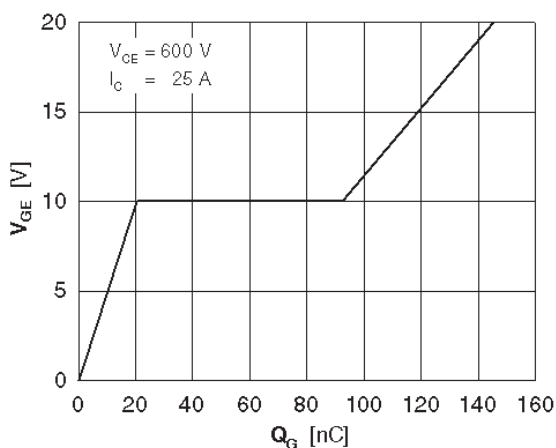


Fig. 5 Typ. turn on gate charge

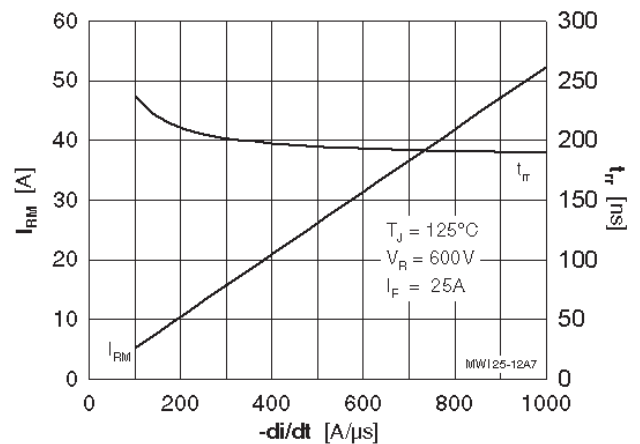


Fig. 6 Typ. turn off characteristics of free wheeling diode

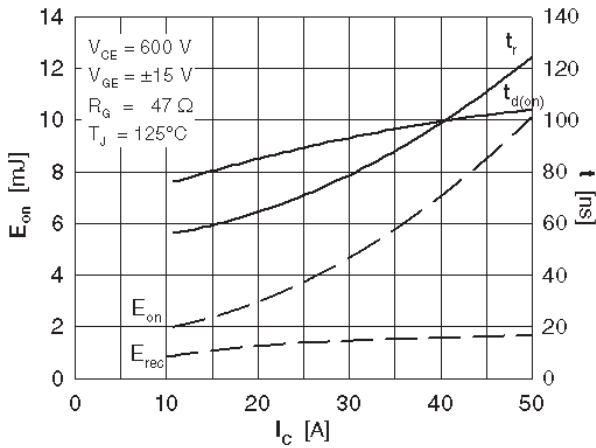


Fig. 7 Typ. turn on energy and switching times versus collector current

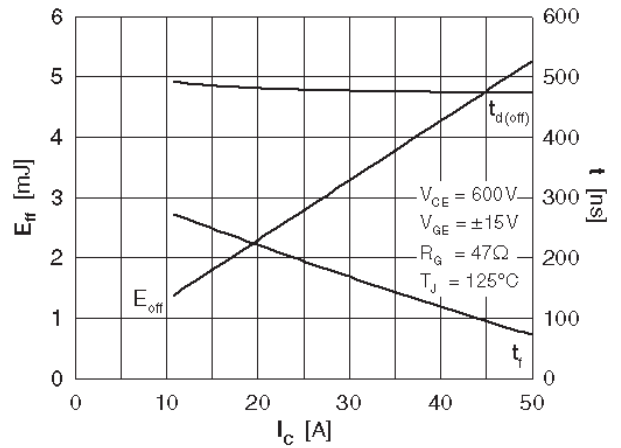


Fig. 8 Typ. turn off energy and switching times versus collector current

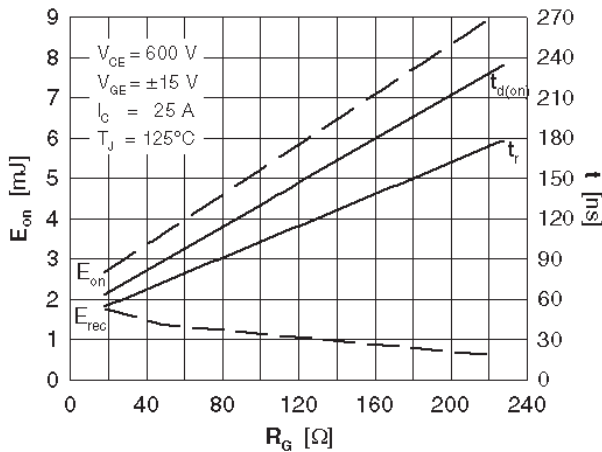


Fig. 9 Typ. turn on energy and switching times versus gate resistor

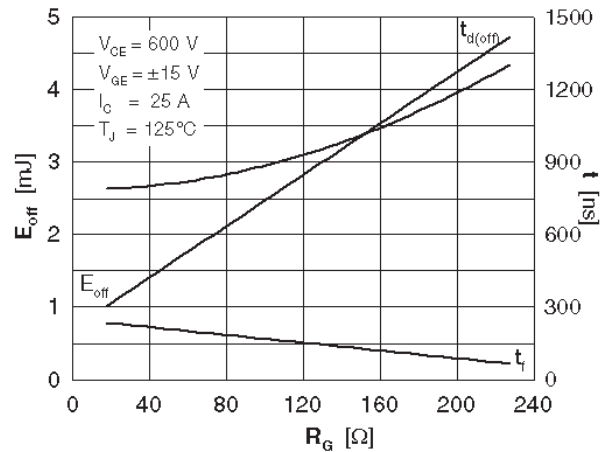


Fig. 10 Typ. turn off energy and switching times versus gate resistor

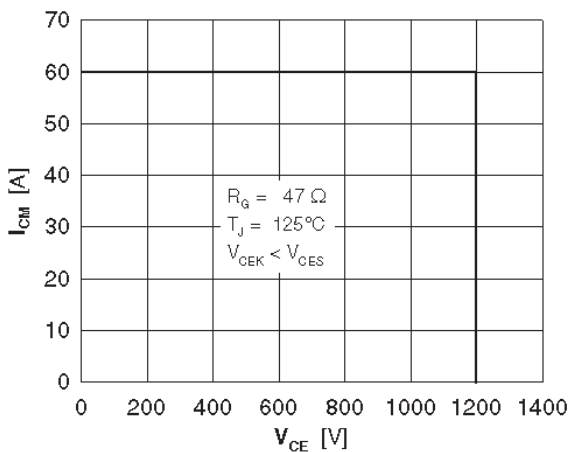


Fig. 11 Reverse biased safe operating area

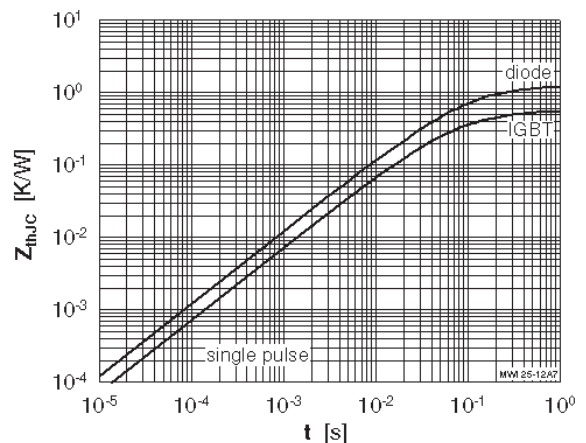


Fig. 12 Typ. transient thermal impedance

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